

N-Channel 30 V (D-S) MOSFET

PRODUCT SUMMARY				
V _{DS} (V)	30			
$R_{DS(on)}(\Omega)$ at $V_{GS} = 10 \text{ V}$	0.025			
$R_{DS(on)}(\Omega)$ at $V_{GS} = 4.5 \text{ V}$	0.038			
I _D (A)	7			
Configuration	Single			

FEATURES

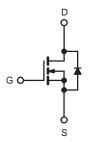
- DT-Trench Power MOSFET
- AEC-Q101 Qualified^c
- \bullet 100 % R_{g} and UIS Tested



RoHS

SOT-223





N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS	(T _C = 25 °C, unles	s otherwise noted	(k		
PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-Source Voltage		V _{DS}	30	.,	
Gate-Source Voltage		V _{GS}	± 20	V	
Continuous Drain Current	T _C = 25 °C	I _D	7		
	T _C = 125 °C		4.5		
Continuous Source Current (Diode Conduction)		Is	5	А	
Pulsed Drain Current ^a		I _{DM}	31		
Single Pulse Avalanche Current	L = 0.1 mH	I _{AS}	10		
Single Pulse Avalanche Energy	L = 0.1 MH	E _{AS}	5	mJ	
Maximum Power Dissipation ^a	T _C = 25 °C	- P _D	4	w	
	T _C = 125 °C		1.3		
Operating Junction and Storage Temperature	Range	T _J , T _{stg}	- 55 to + 175	°C	

THERMAL RESISTANCE RATINGS					
PARAMETER		SYMBOL	LIMIT	UNIT	
Junction-to-Ambient	PCB Mount ^b	R_{thJA}	110	°C/W	
Junction-to-Foot (Drain)		R_{thJF}	38	C/ VV	

Notes

- a. Pulse test; pulse width $\leq 300~\mu s,~duty~cycle \leq 2~\%.$
- b. When mounted on 1" square PCB (FR-4 material).
- c. Parametric verification ongoing.



PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static	<u> </u>			l		I.	<u> </u>
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$		30	-	-	V
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \mu\text{A}$		1.5	2.0	2.5	V
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$		-	-	± 100	nA
Zero Gate Voltage Drain Current		$V_{GS} = 0 V$	V _{DS} = 30 V	-	-	1	μΑ
	I _{DSS}	$V_{GS} = 0 V$	V _{DS} = 30 V, T _J = 125 °C	-	-	50	
		$V_{GS} = 0 V$	V _{DS} = 30 V, T _J = 175 °C	-	-	150	
On-State Drain Current ^a	I _{D(on)}	V _{GS} = 10 V	$V_{DS} \ge 5 V$	10	-	-	Α
Drain-Source On-State Resistance ^a		V _{GS} = 10 V	I _D = 6 A	-	0.018	0.025	
	D	V _{GS} = 4.5 V	I _D = 4.9 A	-	0.032	0.038	Ω
	R _{DS(on)}	V _{GS} = 10 V	I _D = 6 A, T _J = 125 °C	=.	-	0.054	
		V _{GS} = 10 V	I _D = 6 A, T _J = 175 °C	-	-	0.064	
Forward Transconductanceb	9 _{fs}	V _{DS} = 15 V, I _D = 5 A		=.	21	-	S
Dynamic ^b							
Input Capacitance	C _{iss}		V _{DS} = 15 V, f = 1 MHz	=.	295	370	pF
Output Capacitance	C _{oss}	V _{GS} = 0 V		-	67	85	
Reverse Transfer Capacitance	C _{rss}			=.	25	35	
Total Gate Charge ^c	Qg	V _{GS} = 10 V	V _{DS} = 15 V, I _D = 6 A	=.	6	10	nC
Gate-Source Charge ^c	Q _{gs}			-	1.2	-	
Gate-Drain Charge ^c	Q _{gd}			-	1	-	
Gate Resistance	R_g	f = 1 MHz		3.0	6.65	11	Ω
Turn-On Delay Time ^c	t _{d(on)}	V_{DD} = 15 V, R_L = 2.5 Ω $I_D \cong 6$ A, V_{GEN} = 10 V, R_g = 1 Ω		-	6	9	ns
Rise Time ^c	t _r			-	12	18	
Turn-Off Delay Time ^c	t _{d(off)}			-	13	20	
Fall Time ^c	t _f			-	8	12	
Source-Drain Diode Ratings and Chara	acteristics ^b						<u> </u>
Pulsed Current ^a	I _{SM}			-	_	31	Α
Forward Voltage	V _{SD}	I _F = 3 A, V _{GS} = 0 V		_	0.8	1.1	V

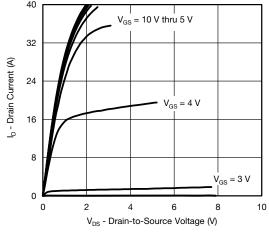
Notes

- a. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%.$
- b. Guaranteed by design, not subject to production testing.
- c. Independent of operating temperature.

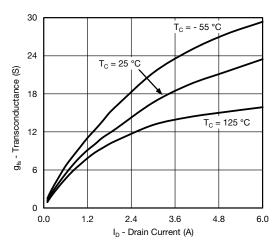
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



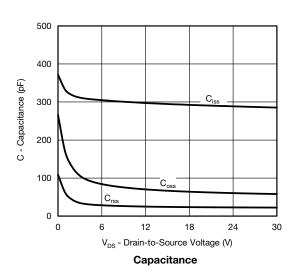
TYPICAL CHARACTERISTICS ($T_A = 25$ °C, unless otherwise noted)

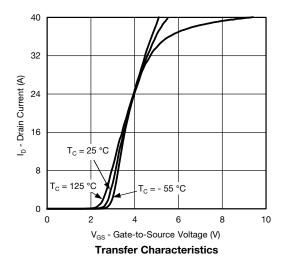


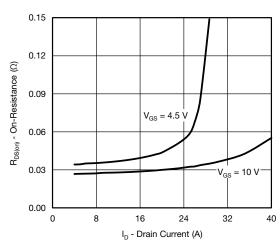
Output Characteristics



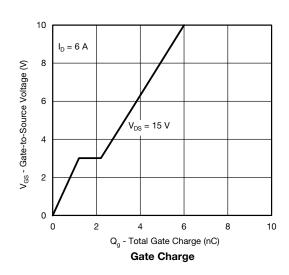
Transconductance





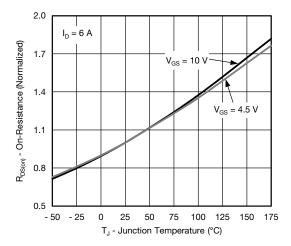


On-Resistance vs. Drain Current

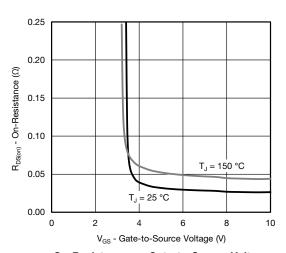




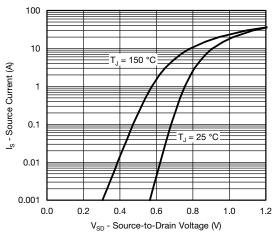
TYPICAL CHARACTERISTICS ($T_A = 25$ °C, unless otherwise noted)



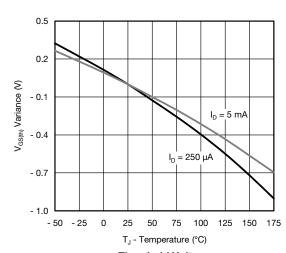
On-Resistance vs. Junction Temperature



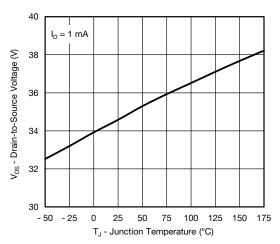
On-Resistance vs. Gate-to-Source Voltage



Source-Drain Diode Forward Voltage



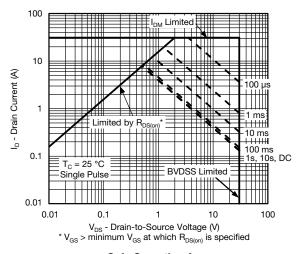
Threshold Voltage



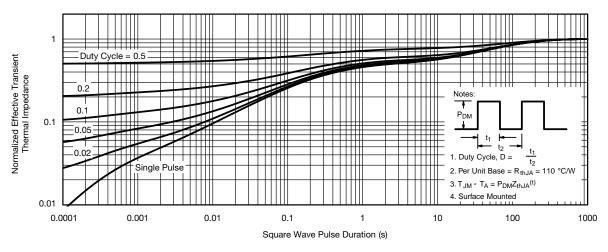
Drain Source Breakdown vs. Junction Temperature



THERMAL RATINGS ($T_A = 25$ °C, unless otherwise noted)



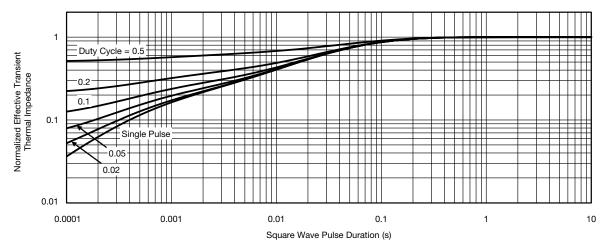
Safe Operating Area



Normalized Thermal Transient Impedance, Junction-to-Ambient



THERMAL RATINGS (T_A = 25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Foot

Note

- The characteristics shown in the two graphs
 - Normalized Transient Thermal Impedance Junction-to-Ambient (25 °C)
 - Normalized Transient Thermal Impedance Junction-to-Foot (25 °C)

are given for general guidelines only to enable the user to get a "ball park" indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board - FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions.





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